

# 3A, 50V - 1000V Surface Mount Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High current capability
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

Δ	D	D		C	Δ	TI	0	N	S
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- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

## **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I <sub>F</sub>	3	Α				
$V_{RRM}$	50 - 1000	V				
I <sub>FSM</sub>	100	Α				
$T_{JMAX}$	150	°C				
Package	DO-214AB (SMC)					
Configuration	Single die					









DO-214AB (SMC)



PARAMETER	SYMBOL	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNIT	
Marking code on the device		S3A	S3B	S3D	S3G	S3J	S3K	S3M		
Repetitive peak reverse vo	$V_{RRM}$	50	100	200	400	600	800	1000	V	
Reverse voltage, total rms	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V	
Forward current		I <sub>F</sub>	3					Α		
Surge peak forward current single half	t = 8.3ms	ı				100				А
sine-wave superimposed on rated load	t = 1.0ms	I <sub>FSM</sub>				230				
Junction temperature		TJ	- 55 to +150				°C			
Storage temperature	T <sub>STG</sub>	- 55 to +150					°C			

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THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance	R <sub>OJL</sub>	13	°C/W			
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	47	°C/W			

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT		
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.15	V		
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	10	μA		
Reverse current @ rated v <sub>R</sub>	T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	250	μA		
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	60	-	pF		
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	1500	-	ns		

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING				
S3x	DO-214AB (SMC)	3,000 / Tape & Reel				

# Notes:

1. "x" defines voltage from 50V(S3A) to 1000V(S3M)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

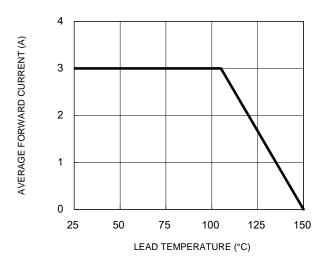


Fig.3 Typical Reverse Characteristics

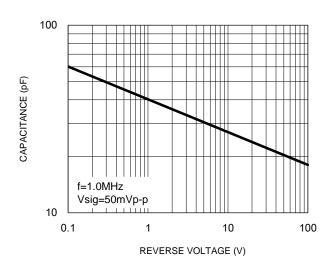
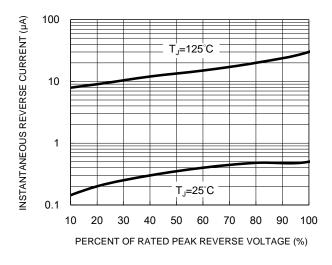


Fig.2 Typical Junction Capacitance

**Fig.4 Typical Forward Characteristics** 



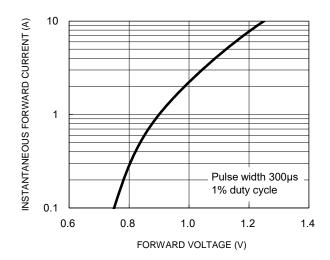
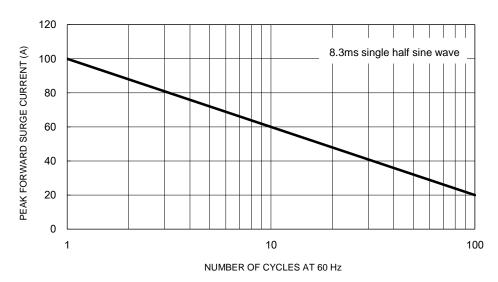


Fig.5 Maximum Non-Repetitive Forward Surge Current

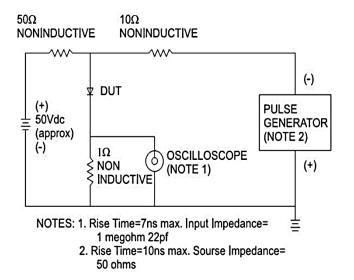


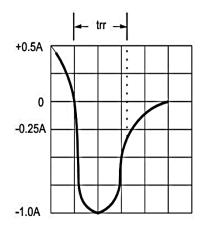


# **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

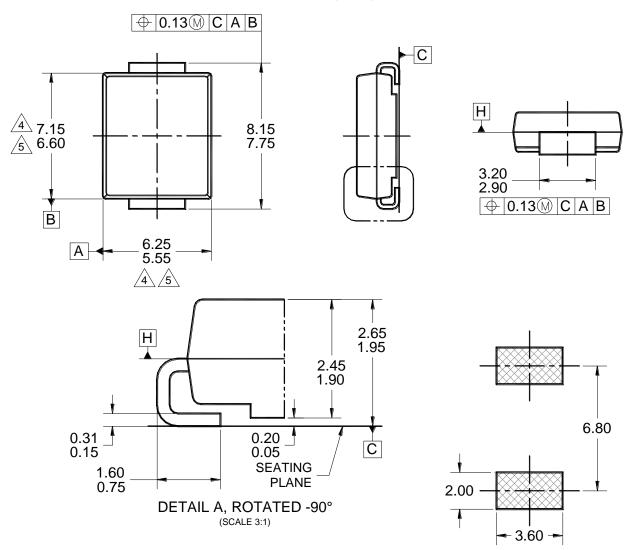


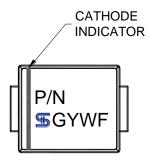




#### **PACKAGE OUTLINE DIMENSIONS**

## **DO-214AB (SMC)**





## MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND

YW = DATE CODE F = FACTORY CODE NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.

SUGGESTED PAD LAYOUT

- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
- 6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.



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